BC640, BC640-16

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Collector – Emitter Breakdown Voltage $(I_C = -10 \text{ mAdc}, I_B = 0)$	V _{(BR)CEO}	-80	_	-	Vdc	
Collector – Base Breakdown Voltage ($I_C = -100 \mu Adc, I_E = 0$)	V _{(BR)CBO}	-80	_	_	Vdc	
Emitter – Base Breakdown Voltage ($I_E = -10 \mu Adc, I_C = 0$)	V _{(BR)EBO}	-5.0	_	_	Vdc	
Collector Cutoff Current $(V_{CB} = -30 \text{ Vdc}, I_E = 0)$ $(V_{CB} = -30 \text{ Vdc}, I_E = 0, T_A = 125^{\circ}\text{C})$	Ісво	- -	- -	-100 -10	nAdc μAdc	
ON CHARACTERISTICS (Note 1)						
DC Current Gain	h _{FE}	25 40 100 25	- - -	_ 160 250 _	-	
Collector – Emitter Saturation Voltage ($I_C = -500 \text{ mAdc}$, $I_B = -50 \text{ mAdc}$)	V _{CE(sat)}	- -	-0.25 -0.5	-0.5 -	Vdc	
Base – Emitter On Voltage ($I_C = -500 \text{ mAdc}$, $V_{CE} = -2.0 \text{ Vdc}$)	V _{BE(on)}	_	_	-1.0	Vdc	
DYNAMIC CHARACTERISTICS						
Current Gain – Bandwidth Product ($I_C = -50$ mAdc, $V_{CE} = -2.0$ Vdc, $f = 100$ MHz)	f _T	-	150	_	MHz	
Output Capacitance $(V_{CB} = -10 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz})$	C _{ob}	_	9.0	_	pF	
Input Capacitance $(V_{EB} = -0.5 \text{ Vdc}, I_C = 0, f = 1.0 \text{ MHz})$	C _{ib}	_	110	_	pF	

^{1.} Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle 2.0%.

ORDERING INFORMATION

Device	Package	Shipping
BC640G	TO-92 (Pb-Free)	5000 Units / Bulk
BC640ZL1G	TO-92 (Pb-Free)	2000 Units / Ammo Box
BC640-16	TO-92	5000 Units / Bulk
BC640-16G	TO-92 (Pb-Free)	5000 Units / Bulk

BC640, BC640-16

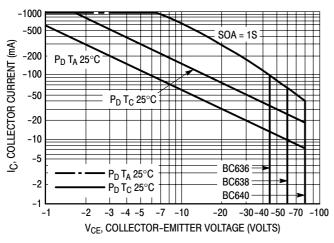
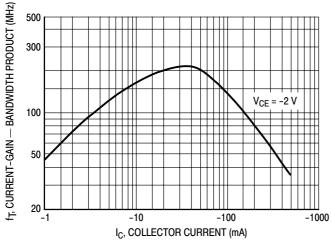


Figure 1. Active Region Safe Operating Area

Figure 2. DC Current Gain



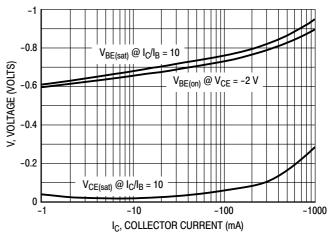


Figure 3. Current Gain Bandwidth Product

Figure 4. "Saturation" and "On" Voltages

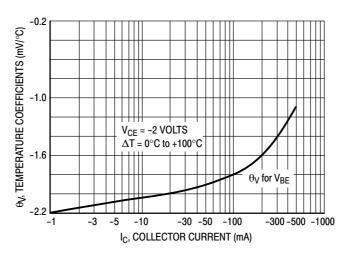
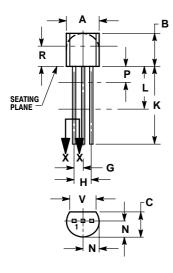


Figure 5. Temperature Coefficients

BC640, BC640-16

PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 **ISSUE AM**



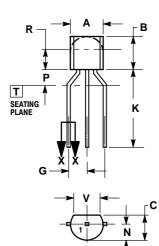
STRAIGHT LEAD **BULK PACK**



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
- LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.45	5.20	
В	0.170	0.210	4.32	5.33	
С	0.125	0.165	3.18	4.19	
D	0.016	0.021	0.407	0.533	
G	0.045	0.055	1.15	1.39	
Н	0.095	0.105	2.42	2.66	
J	0.015	0.020	0.39	0.50	
K	0.500		12.70		
L	0.250		6.35		
N	0.080	0.105	2.04	2.66	
Р		0.100		2.54	
R	0.115		2.93		
٧	0.135		3.43		



BENT LEAD TAPE & REEL AMMO PACK



NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS.
 CONTOUR OF PACKAGE BEYOND
- DIMENSION R IS UNCONTROLLED
- LEAD DIMENSION IS UNCONTROLLED IN PAND BEYOND DIMENSION K MINIMUM.

-				
		MILLIMETERS		
	DIM	MIN	MAX	
	Α	4.45	5.20	
	В	4.32	5.33	
	С	3.18	4.19	
	D	0.40	0.54	
	G	2.40	2.80	
	J	0.39	0.50	
	K	12.70		
	N	2.04	2.66	
	Р	1.50	4.00	
	R	2.93		
	٧	3.43		

STYLE 14:

PIN 1. EMITTER 2.

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